

## $\pm 1^{\circ}\text{C}$ REMOTE TEMPERATURE AND $\pm 2.5^{\circ}\text{C}$ LOCAL TEMPERATURE SENSOR IN SOT23-8

Check for Samples: [TMP422-EP](#)

### FEATURES

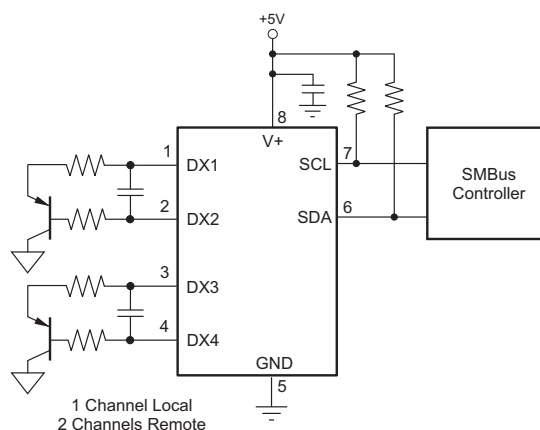
- SOT23-8 Package
- $\pm 1^{\circ}\text{C}$  Remote Diode Sensor (Max)
- $\pm 2.5^{\circ}\text{C}$  Local Temperature Sensor (Max)
- Series Resistance Cancellation
- n-Factor Correction
- Two-Wire/ SMBus™ Serial Interface
- Multiple Interface Addresses
- Diode Fault Detection
- RoHS Compliant and NO Sb/Br

### APPLICATIONS

- Processor/FPGA Temperature Monitoring
- LCD/ DLP®/LCOS Projectors
- Servers
- Central Office Telecom Equipment
- Storage Area Networks (SAN)

### SUPPORTS DEFENSE, AEROSPACE AND MEDICAL APPLICATIONS

- Controlled Baseline
- One Assembly/Test Site
- One Fabrication Site
- Available in Military ( $-55^{\circ}\text{C}$  to  $125^{\circ}\text{C}$ ) Temperature Range<sup>(1)</sup>
- Extended Product Life Cycle
- Extended Product-Change Notification
- Product Traceability



(1) Additional temperature ranges available - contact factory

### DESCRIPTION

The TMP422 is a remote temperature sensor monitor with a built-in local temperature sensor. The remote temperature sensor diode-connected transistors are typically low-cost, NPN- or PNP-type transistors or diodes that are an integral part of microcontrollers, microprocessors, or FPGAs.

Remote accuracy is  $\pm 1^{\circ}\text{C}$  for multiple IC manufacturers, with no calibration needed. The two-wire serial interface accepts SMBus write byte, read byte, send byte, and receive byte commands to configure the device.

The TMP422 includes series resistance cancellation, programmable non-ideality factor, wide remote temperature measurement range (up to  $150^{\circ}\text{C}$ ), and diode fault detection.

The TMP422 is available in a SOT23-8 package.



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This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

**Table 1. ORDERING INFORMATION<sup>(1)</sup>**

| PRODUCT | ORDERABLE PART NUMBER | PACKAGE-LEAD | PACKAGE DESIGNATOR <sup>(2)</sup> | PACKAGE MARKING | VID NUMBER     |
|---------|-----------------------|--------------|-----------------------------------|-----------------|----------------|
| TMP422  | TMP422AMDCNTEP        | SOT23-8      | DCN                               | TMP4            | V62/11618-01XE |

- (1) For the most current package and ordering information see the Package Option Addendum at the end of this document, or see the TI web site at [www.ti.com](http://www.ti.com).
- (2) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).

## ABSOLUTE MAXIMUM RATINGS<sup>(1)</sup>

Over operating free-air temperature range, unless otherwise noted.

|                                   |                            | TMP422              | UNIT |
|-----------------------------------|----------------------------|---------------------|------|
| Power Supply, $V_S$               |                            | +7                  | V    |
| Input Voltage                     | Pins 1, 2, 3, and 4 only   | −0.5 to $V_S + 0.5$ | V    |
|                                   | Pins 6 and 7 only          | −0.5 to 7           | V    |
| Input Current                     |                            | 10                  | mA   |
| Power dissipation, $P_D$          |                            | 230                 | mW   |
| Storage Temperature Range         |                            | −65 to +150         | °C   |
| Junction Temperature ( $T_J$ max) |                            | +150                | °C   |
| ESD Rating                        | Human Body Model (HBM)     | 3000                | V    |
|                                   | Charged Device Model (CDM) | 1000                | V    |
|                                   | Machine Model (MM)         | 200                 | V    |

- (1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those specified is not implied.

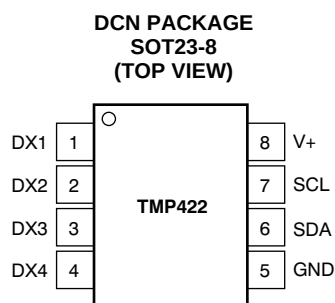
## ELECTRICAL CHARACTERISTICS

At  $T_A = -55^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$  and  $V_S = 2.7\text{V}$  to  $5.5\text{V}$ , unless otherwise noted.

| PARAMETER                                                          | CONDITIONS                                                                                                                          | MIN     | TYP        | MAX        | UNIT                 |
|--------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------|---------|------------|------------|----------------------|
| <b>TEMPERATURE ERROR</b>                                           |                                                                                                                                     |         |            |            |                      |
| Local Temperature Sensor $TE_{\text{LOCAL}}$                       | $T_A = -55^{\circ}\text{C}$ to $+125^{\circ}\text{C}$                                                                               |         | $\pm 1.25$ | $\pm 2.5$  | $^{\circ}\text{C}$   |
| Remote Temperature Sensor <sup>(1)</sup> $TE_{\text{REMOTE}}$      | $T_A = +15^{\circ}\text{C}$ to $+85^{\circ}\text{C}$ , $T_D = -55^{\circ}\text{C}$ to $+125^{\circ}\text{C}$ , $V_S = 3.3\text{V}$  |         | 0.25       | $\pm 1$    | $^{\circ}\text{C}$   |
|                                                                    | $T_A = -55^{\circ}\text{C}$ to $+125^{\circ}\text{C}$ , $T_D = -55^{\circ}\text{C}$ to $+125^{\circ}\text{C}$ , $V_S = 3.3\text{V}$ |         | $\pm 1$    | $\pm 3$    | $^{\circ}\text{C}$   |
|                                                                    | $T_A = -55^{\circ}\text{C}$ to $+125^{\circ}\text{C}$ , $T_D = -55^{\circ}\text{C}$ to $+125^{\circ}\text{C}$                       |         | $\pm 3$    | $\pm 5$    | $^{\circ}\text{C}$   |
| vs Supply (Local/Remote)                                           | $V_S = 2.7\text{V}$ to $5.5\text{V}$                                                                                                |         | $\pm 0.2$  | $\pm 0.72$ | $^{\circ}\text{C/V}$ |
| <b>TEMPERATURE MEASUREMENT</b>                                     |                                                                                                                                     |         |            |            |                      |
| Conversion Time (per channel)                                      |                                                                                                                                     | 100     | 115        | 130        | ms                   |
| Resolution                                                         |                                                                                                                                     |         |            |            |                      |
| Local Temperature Sensor (programmable)                            |                                                                                                                                     |         | 12         |            | Bits                 |
| Remote Temperature Sensor                                          |                                                                                                                                     |         | 12         |            | Bits                 |
| Remote Sensor Source Currents                                      |                                                                                                                                     |         |            |            |                      |
| High                                                               | Series Resistance $3\text{k}\Omega$ Max                                                                                             |         | 120        |            | $\mu\text{A}$        |
| Medium High                                                        |                                                                                                                                     |         | 60         |            | $\mu\text{A}$        |
| Medium Low                                                         |                                                                                                                                     |         | 12         |            | $\mu\text{A}$        |
| Low                                                                |                                                                                                                                     |         | 6          |            | $\mu\text{A}$        |
| Remote Transistor Ideality Factor $\eta$                           | Optimized Ideality Factor                                                                                                           |         | 1.008      |            |                      |
| <b>SMBus INTERFACE</b>                                             |                                                                                                                                     |         |            |            |                      |
| Logic Input High Voltage (SCL, SDA) $V_{\text{IH}}$                |                                                                                                                                     | 2.1     |            |            | V                    |
| Logic Input Low Voltage (SCL, SDA) $V_{\text{IL}}$                 |                                                                                                                                     |         |            | 0.8        | V                    |
| Hysteresis                                                         |                                                                                                                                     |         | 500        |            | mV                   |
| SMBus Output Low Sink Current                                      |                                                                                                                                     | 6       |            |            | mA                   |
| SDA Output Low Voltage $V_{\text{OL}}$                             | $I_{\text{OUT}} = 6\text{mA}$                                                                                                       |         | 0.15       | 0.4        | V                    |
| Logic Input Current                                                | $0 \leq V_{\text{IN}} \leq 6\text{V}$                                                                                               | -1      |            | +1         | $\mu\text{A}$        |
| SMBus Input Capacitance (SCL, SDA)                                 |                                                                                                                                     |         | 3          |            | pF                   |
| SMBus Clock Frequency                                              |                                                                                                                                     |         |            | 3.4        | MHz                  |
| SMBus Timeout                                                      |                                                                                                                                     | 25      | 30         | 35         | ms                   |
| SCL Falling Edge to SDA Valid Time                                 |                                                                                                                                     |         |            | 1          | $\mu\text{s}$        |
| <b>DIGITAL INPUTS</b>                                              |                                                                                                                                     |         |            |            |                      |
| Input Capacitance                                                  |                                                                                                                                     |         | 3          |            | pF                   |
| Input Logic Levels                                                 |                                                                                                                                     |         |            |            |                      |
| Input High Voltage $V_{\text{IH}}$                                 |                                                                                                                                     | 0.7(V+) |            | (V+)+0.5   | V                    |
| Input Low Voltage $V_{\text{IL}}$                                  |                                                                                                                                     | -0.5    |            | 0.3(V+)    | V                    |
| Leakage Input Current $I_{\text{IN}}$                              | $0\text{V} \leq V_{\text{IN}} \leq V_S$                                                                                             |         |            | 1          | $\mu\text{A}$        |
| <b>POWER SUPPLY</b>                                                |                                                                                                                                     |         |            |            |                      |
| Specified Voltage Range $V_S$                                      |                                                                                                                                     | 2.7     |            | 5.5        | V                    |
| Quiescent Current $I_Q$                                            | 0.0625 Conversions per Second                                                                                                       |         | 32         | 38         | $\mu\text{A}$        |
|                                                                    | Eight Conversions per Second                                                                                                        |         | 400        | 525        | $\mu\text{A}$        |
|                                                                    | Serial Bus Inactive, Shutdown Mode                                                                                                  |         | 3          | 10         | $\mu\text{A}$        |
|                                                                    | Serial Bus Active, $f_S = 400\text{kHz}$ , Shutdown Mode                                                                            |         | 90         |            | $\mu\text{A}$        |
|                                                                    | Serial Bus Active, $f_S = 3.4\text{MHz}$ , Shutdown Mode                                                                            |         | 350        |            | $\mu\text{A}$        |
| Undervoltage Lockout $\text{UVLO}$                                 |                                                                                                                                     | 2.3     | 2.4        | 2.6        | V                    |
| Power-On Reset Threshold $\text{POR}$                              |                                                                                                                                     |         | 1.6        | 2.3        | V                    |
| <b>TEMPERATURE RANGE</b>                                           |                                                                                                                                     |         |            |            |                      |
| Specified Range                                                    |                                                                                                                                     | -55     |            | +125       | $^{\circ}\text{C}$   |
| Thermal Resistance, junction-to-ambient SOT23 $\theta_{\text{JA}}$ |                                                                                                                                     |         | 164        |            | $^{\circ}\text{C/W}$ |
| Thermal Resistance, junction-to-case SOT23 $\theta_{\text{JC}}$    |                                                                                                                                     |         | 108        |            | $^{\circ}\text{C/W}$ |

(1) Tested with less than  $5\Omega$  effective series resistance and  $100\text{pF}$  differential input capacitance.

## PIN CONFIGURATION



## PIN ASSIGNMENTS

| TMP422 |      | DESCRIPTION                                                                                                      |
|--------|------|------------------------------------------------------------------------------------------------------------------|
| NO.    | NAME |                                                                                                                  |
| 1      | DX1  | Channel 1 remote temperature sensor connection pin. Also sets the TMP422 address; see <a href="#">Table 10</a> . |
| 2      | DX2  | Channel 1 remote temperature sensor connection pin. Also sets the TMP422 address; see <a href="#">Table 10</a> . |
| 3      | DX3  | Channel 2 remote temperature sensor connection pin. Also sets the TMP422 address; see <a href="#">Table 10</a> . |
| 4      | DX4  | Channel 2 remote temperature sensor connection pin. Also sets the TMP422 address; see <a href="#">Table 10</a> . |
| 5      | GND  | Ground                                                                                                           |
| 6      | SDA  | Serial data line for SMBus, open-drain; requires pull-up resistor to V+.                                         |
| 7      | SCL  | Serial clock line for SMBus, open-drain; requires pull-up resistor to V+.                                        |
| 8      | V+   | Positive supply voltage (2.7V to 5.5V)                                                                           |

## TYPICAL CHARACTERISTICS

At  $T_A = +25^\circ\text{C}$  and  $V_S = +5.0\text{V}$ , unless otherwise noted.

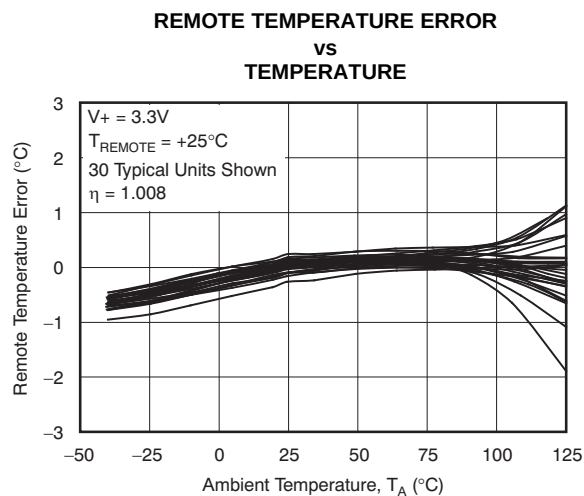


Figure 1.

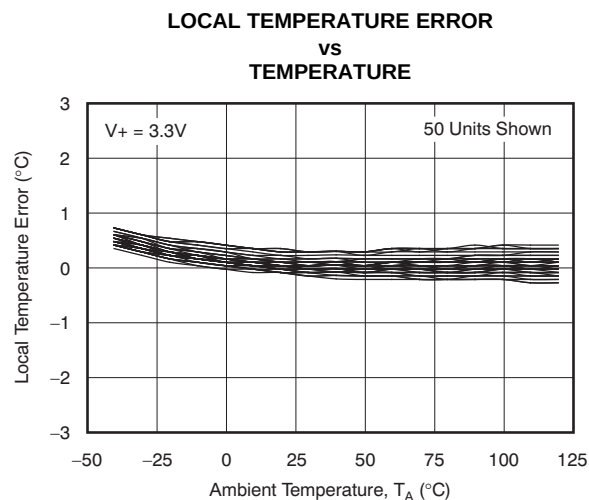


Figure 2.

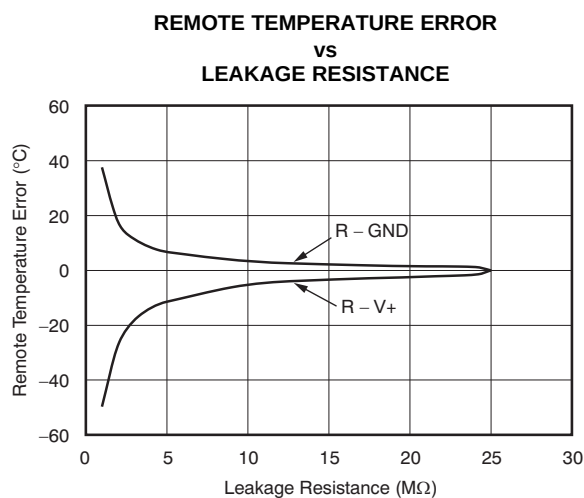


Figure 3.

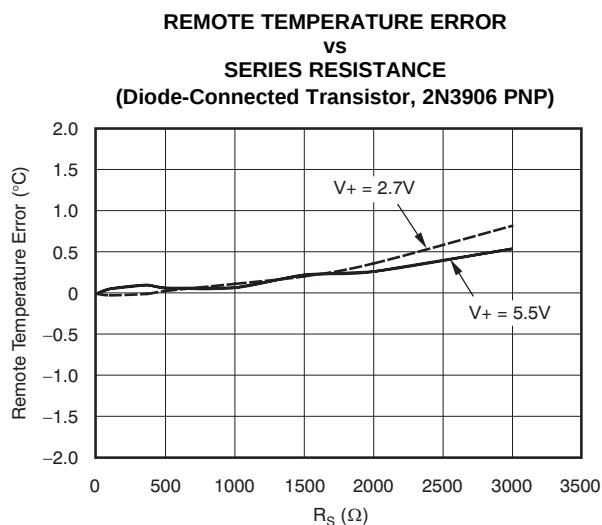


Figure 4.

## TYPICAL CHARACTERISTICS (continued)

At  $T_A = +25^\circ\text{C}$  and  $V_S = +5.0\text{V}$ , unless otherwise noted.

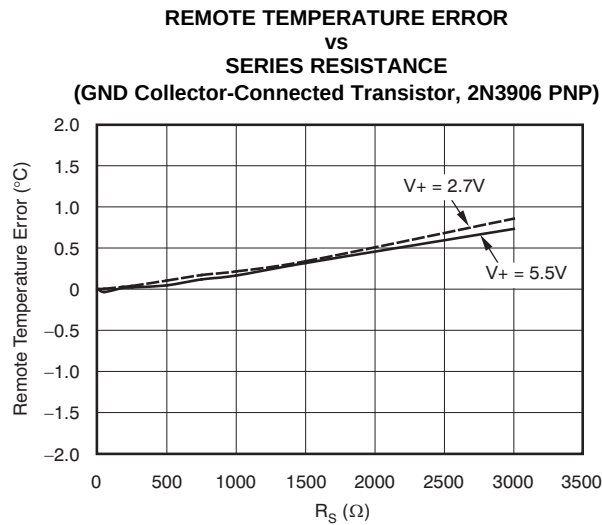


Figure 5.

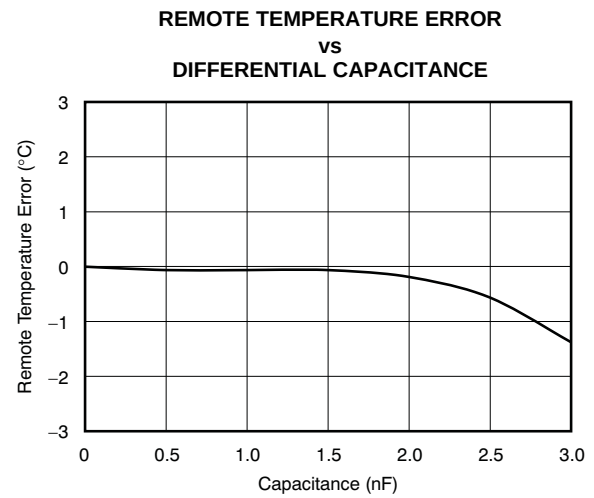


Figure 6.

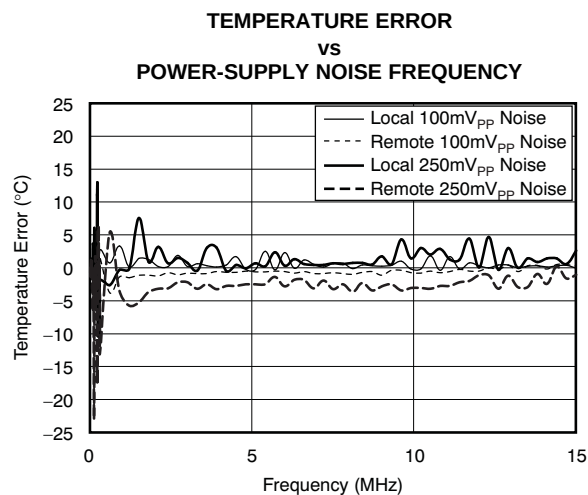


Figure 7.

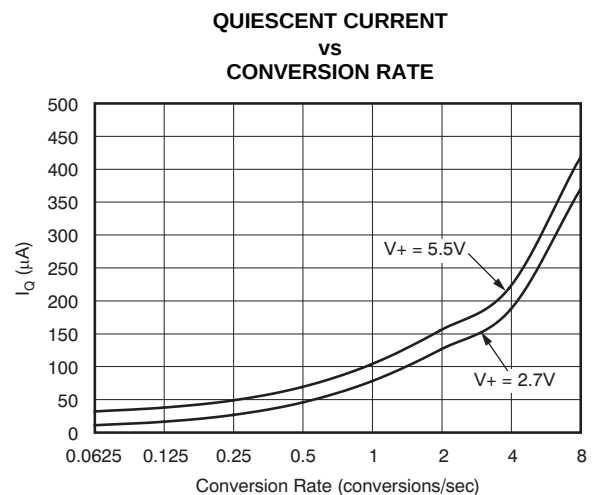
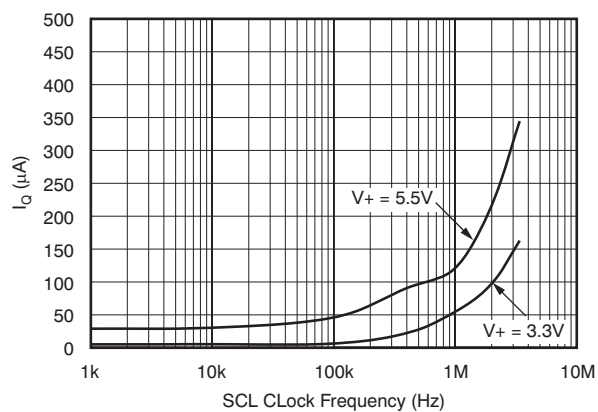


Figure 8.

## TYPICAL CHARACTERISTICS (continued)

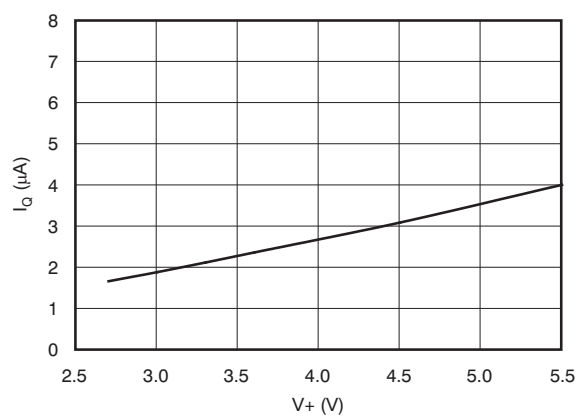
At  $T_A = +25^\circ\text{C}$  and  $V_S = +5.0\text{V}$ , unless otherwise noted.

**SHUTDOWN QUIESCENT CURRENT  
vs  
SCL CLOCK FREQUENCY**



**Figure 9.**

**SHUTDOWN QUIESCENT CURRENT  
vs  
SUPPLY VOLTAGE**



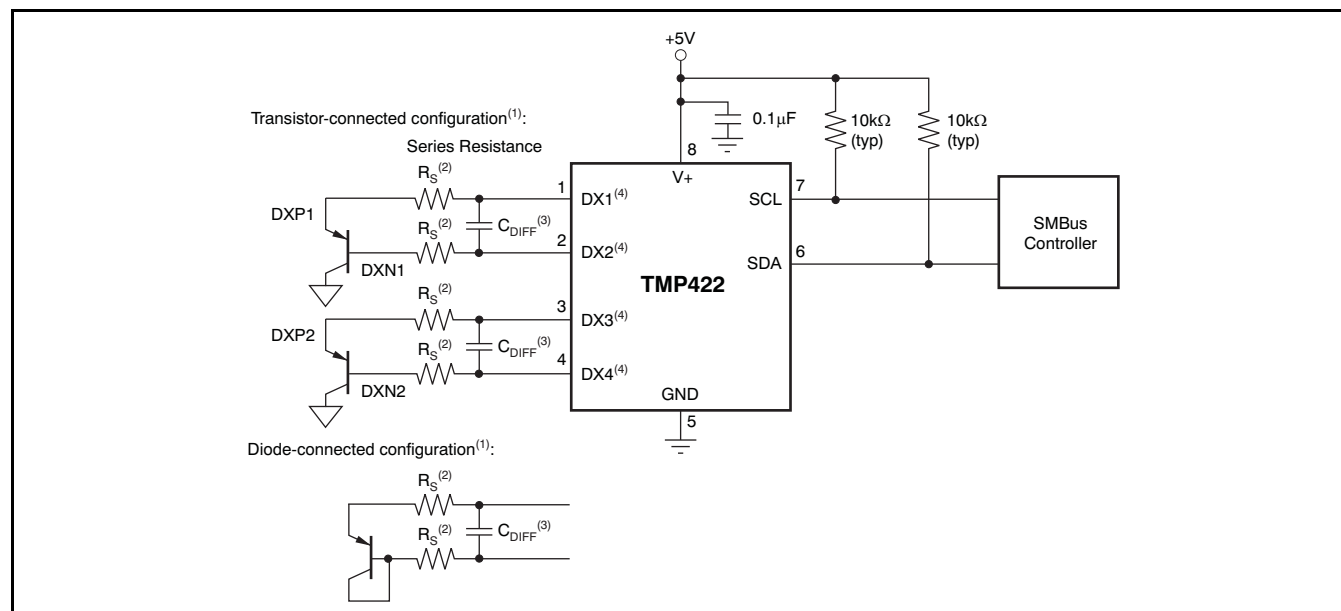
**Figure 10.**

## APPLICATION INFORMATION

The TMP422 (three-channel) is a digital temperature sensor that combines a local die temperature measurement channel and two remote junction temperature measurement channels in a single SOT23-8 package. This device is two-wire- and SMBus interface-compatible and are specified over a temperature range of  $-55^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$ . The TMP422 contains multiple registers for holding configuration information and temperature measurement results.

The TMP422 requires transistors connected between DX1 and DX2 and between DX3 and DX4. Unused channels on the TMP422 must be connected to GND.

The TMP422 SCL and SDA interface pins each require pull-up resistors as part of the communication bus. A  $0.1\mu\text{F}$  power-supply bypass capacitor is recommended for local bypassing. Figure 11 illustrates a typical application for the TMP422.



(1) Diode-connected configuration provides better settling time. Transistor-connected configuration provides better series resistance cancellation.

(2)  $R_S$  (optional) should be  $< 1.5\text{k}\Omega$  in most applications. Selection of  $R_S$  depends on application; see the [Filtering](#) section.

(3)  $C_{\text{DIFF}}$  (optional) should be  $< 1000\text{pF}$  in most applications. Selection of  $C_{\text{DIFF}}$  depends on application; see the [Filtering](#) section and [Figure 6, Remote Temperature Error vs Differential Capacitance](#).

(4) TMP422 SMBus slave address is **1001 100** when connected as shown.

**Figure 11. TMP422 Basic Connections**

## SERIES RESISTANCE CANCELLATION

Series resistance in an application circuit that typically results from printed circuit board (PCB) trace resistance and remote line length is automatically cancelled by the TMP422, preventing what would otherwise result in a temperature offset. A total of up to 3k $\Omega$  of series line resistance is cancelled by the TMP422, eliminating the need for additional characterization and temperature offset correction. See the two *Remote Temperature Error vs Series Resistance* typical characteristic curves ([Figure 4](#) and [Figure 5](#)) for details on the effects of series resistance and power-supply voltage on sensed remote temperature error.

## DIFFERENTIAL INPUT CAPACITANCE

The TMP422 tolerates differential input capacitance of up to 1000pF with minimal change in temperature error. The effect of capacitance on sensed remote temperature error is illustrated in [Figure 6](#), *Remote Temperature Error vs Differential Capacitance*.

## TEMPERATURE MEASUREMENT DATA

Temperature measurement data may be taken over an operating range of  $-40^{\circ}\text{C}$  to  $+127^{\circ}\text{C}$  for both local and remote locations.

However, measurements from  $-55^{\circ}\text{C}$  to  $+150^{\circ}\text{C}$  can be made both locally and remotely by reconfiguring the TMP422 for the extended temperature range, as described below.

Temperature data that result from conversions within the default measurement range are represented in binary form, as shown in [Table 2](#), Standard Binary column. Note that although the device is rated to only measure temperatures down to  $-55^{\circ}\text{C}$ , it may read temperatures below this level. However, any temperature below  $-64^{\circ}\text{C}$  results in a data value of  $-64$  (C0h). Likewise, temperatures above  $+127^{\circ}\text{C}$  result in a value of 127 (7Fh). The device can be set to measure over an extended temperature range by changing bit 2 (RANGE) of Configuration Register 1 from low to high. The change in measurement range and data format from standard binary to extended binary occurs at the next temperature conversion. For data captured in the extended temperature range configuration, an offset of 64 (40h) is added to the standard binary value, as shown in the *Extended Binary* column of [Table 2](#). This configuration allows measurement of temperatures as low as  $-64^{\circ}\text{C}$ , and as high as  $+191^{\circ}\text{C}$ ; however, most temperature-sensing diodes only measure with the range of  $-55^{\circ}\text{C}$  to  $+150^{\circ}\text{C}$ . Additionally, the TMP422 is rated only for ambient temperatures ranging from  $-55^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$ . Parameters in the [Absolute Maximum Ratings](#) table must be observed.

**Table 2. Temperature Data Format (Local and Remote Temperature High Bytes)**

| TEMP<br>( $^{\circ}\text{C}$ ) | LOCAL/REMOTE TEMPERATURE REGISTER<br>HIGH BYTE VALUE ( $1^{\circ}\text{C}$ RESOLUTION) |     |                                |     |
|--------------------------------|----------------------------------------------------------------------------------------|-----|--------------------------------|-----|
|                                | STANDARD BINARY <sup>(1)</sup>                                                         |     | EXTENDED BINARY <sup>(2)</sup> |     |
|                                | BINARY                                                                                 | HEX | BINARY                         | HEX |
| -64                            | 1100 0000                                                                              | C0  | 0000 0000                      | 00  |
| -50                            | 1100 1110                                                                              | CE  | 0000 1110                      | 0E  |
| -25                            | 1110 0111                                                                              | E7  | 0010 0111                      | 27  |
| 0                              | 0000 0000                                                                              | 00  | 0100 0000                      | 40  |
| 1                              | 0000 0001                                                                              | 01  | 0100 0001                      | 41  |
| 5                              | 0000 0101                                                                              | 05  | 0100 0101                      | 45  |
| 10                             | 0000 1010                                                                              | 0A  | 0100 1010                      | 4A  |
| 25                             | 0001 1001                                                                              | 19  | 0101 1001                      | 59  |
| 50                             | 0011 0010                                                                              | 32  | 0111 0010                      | 72  |
| 75                             | 0100 1011                                                                              | 4B  | 1000 1011                      | 8B  |
| 100                            | 0110 0100                                                                              | 64  | 1010 0100                      | A4  |
| 125                            | 0111 1101                                                                              | 7D  | 1011 1101                      | BD  |
| 127                            | 0111 1111                                                                              | 7F  | 1011 1111                      | BF  |
| 150                            | 0111 1111                                                                              | 7F  | 1101 0110                      | D6  |
| 175                            | 0111 1111                                                                              | 7F  | 1110 1111                      | EF  |
| 191                            | 0111 1111                                                                              | 7F  | 1111 1111                      | FF  |

(1) Resolution is  $1^{\circ}\text{C}/\text{count}$ . Negative numbers are represented in two's complement format.

(2) Resolution is  $1^{\circ}\text{C}/\text{count}$ . All values are unsigned with a  $-64^{\circ}\text{C}$  offset.

Both local and remote temperature data use two bytes for data storage. The high byte stores the temperature with 1°C resolution. The second or low byte stores the decimal fraction value of the temperature and allows a higher measurement resolution, as shown in Table 3. The measurement resolution for the both the local and remote channels is 0.0625°C, and is not adjustable.

**Table 3. Decimal Fraction Temperature Data Format (Local and Remote Temperature Low Bytes)**

| TEMP<br>(°C) | TEMPERATURE REGISTER LOW BYTE VALUE<br>(0.0625°C RESOLUTION)(1) |     |
|--------------|-----------------------------------------------------------------|-----|
|              | STANDARD AND EXTENDED BINARY                                    | HEX |
| 0            | 0000 0000                                                       | 00  |
| 0.0625       | 0001 0000                                                       | 10  |
| 0.1250       | 0010 0000                                                       | 20  |
| 0.1875       | 0011 0000                                                       | 30  |
| 0.2500       | 0100 0000                                                       | 40  |
| 0.3125       | 0101 0000                                                       | 50  |
| 0.3750       | 0110 0000                                                       | 60  |
| 0.4375       | 0111 0000                                                       | 70  |
| 0.5000       | 1000 0000                                                       | 80  |
| 0.5625       | 1001 0000                                                       | 90  |
| 0.6250       | 1010 0000                                                       | A0  |
| 0.6875       | 1011 0000                                                       | B0  |
| 0.7500       | 1100 0000                                                       | C0  |
| 0.8125       | 1101 0000                                                       | D0  |
| 0.8750       | 1110 0000                                                       | E0  |
| 0.9385       | 1111 0000                                                       | F0  |

(1) Resolution is 0.0625°C/count. All possible values are shown.

## Standard Binary to Decimal Temperature Data Calculation Example

High byte conversion (for example, 0111 0011):

Convert the right-justified binary high byte to hexadecimal.

From hexadecimal, multiply the first number by  $16^0 = 1$  and the second number by  $16^1 = 16$ .

The sum equals the decimal equivalent.

$$0111\ 0011b \rightarrow 73h \rightarrow (3 \times 16^0) + (7 \times 16^1) = 115$$

Low byte conversion (for example, 0111 0000):

To convert the left-justified binary low-byte to decimal, use bits 7 through 4 and ignore bits 3 through 0 because they do not affect the value of the number.

$$0111b \rightarrow (0 \times 1/2)^1 + (1 \times 1/2)^2 + (1 \times 1/2)^3 + (1 \times 1/2)^4 = 0.4375$$

Note that the final numerical result is the sum of the high byte and low byte. In negative temperatures, the unsigned low byte adds to the negative high byte to result in a value less than the high byte (for instance,  $-15 + 0.75 = -14.25$ , not  $-15.75$ ).

## Standard Decimal to Binary Temperature Data Calculation Example

For positive temperatures (for example, +20°C):

$$(+20^\circ\text{C})/(+1^\circ\text{C}/\text{count}) = 20 \rightarrow 14h \rightarrow 0001\ 0100$$

Convert the number to binary code with 8-bit, right-justified format, and MSB = '0' to denote a positive sign.

+20°C is stored as 0001 0100 → 14h.

For negative temperatures (for example, -20°C):

$$(|-20|)/(+1^\circ\text{C}/\text{count}) = 20 \rightarrow 14h \rightarrow 0001\ 0100$$

Generate the two's complement of a negative number by complementing the absolute value binary number and adding 1.

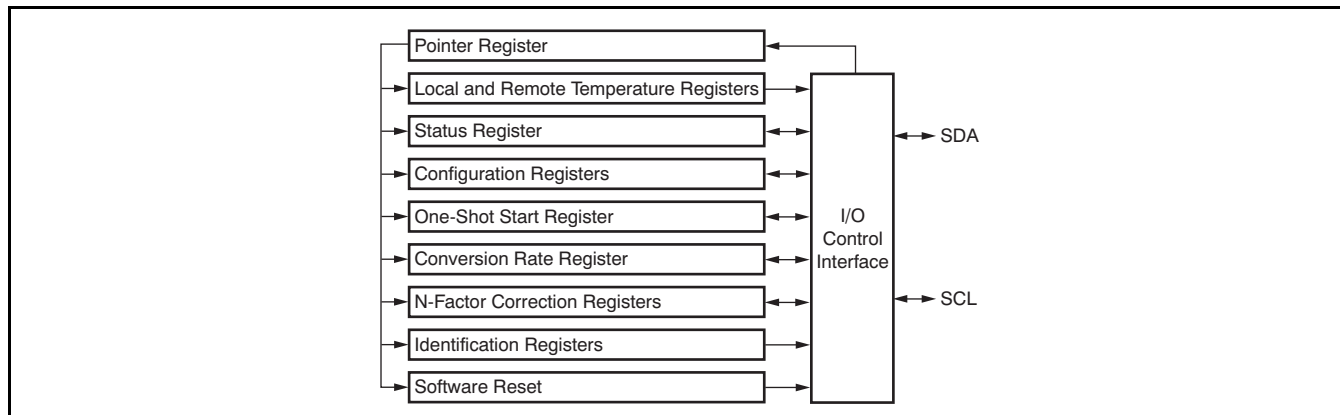
-20°C is stored as 1110 1100 → ECh.

## REGISTER INFORMATION

The TMP422 contains multiple registers for holding configuration information, temperature measurement results, and status information. These registers are described in [Figure 12](#) and [Table 4](#).

## POINTER REGISTER

[Figure 12](#) shows the internal register structure of the TMP422. The 8-bit Pointer Register is used to address a given data register. The Pointer Register identifies which of the data registers should respond to a read or write command on the two-wire bus. This register is set with every write command. A write command must be issued to set the proper value in the Pointer Register before executing a read command. [Table 4](#) describes the pointer address of the TMP422 registers. The power-on reset (POR) value of the Pointer Register is 00h (0000 0000b).



**Figure 12. Internal Register Structure**

**Table 4. Register Map**

| POINTER<br>(HEX) | POR (HEX) | BIT DESCRIPTION |      |      |     |     |       |                          |      | REGISTER DESCRIPTION                            |
|------------------|-----------|-----------------|------|------|-----|-----|-------|--------------------------|------|-------------------------------------------------|
|                  |           | 7               | 6    | 5    | 4   | 3   | 2     | 1                        | 0    |                                                 |
| 00               | 00        | LT11            | LT10 | LT9  | LT8 | LT7 | LT6   | LT5                      | LT4  | Local Temperature (High Byte) <sup>(1)</sup>    |
| 01               | 00        | RT11            | RT10 | RT9  | RT8 | RT7 | RT6   | RT5                      | RT4  | Remote Temperature 1 (High Byte) <sup>(1)</sup> |
| 02               | 00        | RT11            | RT10 | RT9  | RT8 | RT7 | RT6   | RT5                      | RT4  | Remote Temperature 2 (High Byte) <sup>(1)</sup> |
| 03               | 00        | RT11            | RT10 | RT9  | RT8 | RT7 | RT6   | RT5                      | RT4  | Remote Temperature 3 (High Byte) <sup>(1)</sup> |
| 08               |           | BUSY            | 0    | 0    | 0   | 0   | 0     | 0                        | 0    | Status Register                                 |
| 09               | 00        | 0               | SD   | 0    | 0   | 0   | RANGE | 0                        | 0    | Configuration Register 1                        |
| 0A               | 1C/3C     | 0               | REN3 | REN2 | REN | LEN | RC    | 0                        | 0    | Configuration Register 2                        |
| 0B               | 07        | 0               | 0    | 0    | 0   | 0   | R2    | R1                       | R0   | Conversion Rate Register                        |
| 0F               |           | X               | X    | X    | X   | X   | X     | X                        | X    | One-Shot Start <sup>(2)</sup>                   |
| 10               | 00        | LT3             | LT2  | LT1  | LT0 | 0   | 0     | $\overline{\text{PVLD}}$ | 0    | Local Temperature (Low Byte)                    |
| 11               | 00        | RT3             | RT2  | RT1  | RT0 | 0   | 0     | $\overline{\text{PVLD}}$ | OPEN | Remote Temperature 1 (Low Byte)                 |
| 12               | 00        | RT3             | RT2  | RT1  | RT0 | 0   | 0     | $\overline{\text{PVLD}}$ | OPEN | Remote Temperature 2 (Low Byte)                 |
| 13               | 00        | RT3             | RT2  | RT1  | RT0 | 0   | 0     | $\overline{\text{PVLD}}$ | OPEN | Remote Temperature 3 (Low Byte)                 |
| 21               | 00        | NC7             | NC6  | NC5  | NC4 | NC3 | NC2   | NC1                      | NC0  | N Correction 1                                  |
| 22               | 00        | NC7             | NC6  | NC5  | NC4 | NC3 | NC2   | NC1                      | NC0  | N Correction 2                                  |
| 23               | 00        | NC7             | NC6  | NC5  | NC4 | NC3 | NC2   | NC1                      | NC0  | N Correction 3                                  |
| FC               |           | X               | X    | X    | X   | X   | X     | X                        | X    | Software Reset <sup>(3)</sup>                   |
| FE               | 55        | 0               | 1    | 0    | 1   | 0   | 1     | 0                        | 1    | Manufacturer ID                                 |
| FF               | 21        | 0               | 0    | 1    | 0   | 0   | 0     | 1                        | 0    | TMP422 Device ID                                |

(1) Compatible with Two-Byte Read; see [Figure 17](#).

(2) X = undefined. Writing any value to this register initiates a one-shot start; see the [One-Shot Conversion](#) section.

(3) X = undefined. Writing any value to this register initiates a software reset; see the [Software Reset](#) section.

## TEMPERATURE REGISTERS

The TMP422 has multiple 8-bit registers that hold temperature measurement results. The local channel and each of the remote channels have a high byte register that contains the most significant bits (MSBs) of the temperature analog-to-digital converter (ADC) result and a low byte register that contains the least significant bits (LSBs) of the temperature ADC result. The local channel high byte address is 00h; the local channel low byte address is 10h. The remote channel high byte is at address 01h; the remote channel low byte address is 11h. For the TMP422, the second remote channel high byte address is 02h; the second remote channel low byte is 12h. These registers are read-only and are updated by the ADC each time a temperature measurement is completed.

The TMP422 contains circuitry to assure that a low byte register read command returns data from the same ADC conversion as the immediately preceding high byte read command. This assurance remains valid only until another register is read. For proper operation, the high byte of a temperature register should be read first. The low byte register should be read in the next read command. The low byte register may be left unread if the LSBs are not needed. Alternatively, the temperature registers may be read as a 16-bit register by using a single two-byte read command from address 00h for the local channel result, or from address 01h for the remote channel result (02h for the second remote channel result, and 03h for the third remote channel). The high byte is output first, followed by the low byte. Both bytes of this read operation are from the same ADC conversion. The power-on reset value of all temperature registers is 00h.

## STATUS REGISTER

The Status Register reports the state of the temperature ADCs. [Table 5](#) summarizes the Status Register bits. The Status Register is read-only, and is read by accessing pointer address 08h.

The BUSY bit = '1' if the ADC is making a conversion; it is set to '0' if the ADC is not converting.

## CONFIGURATION REGISTER 1

Configuration Register 1 (pointer address 09h) sets the temperature range and controls the shutdown mode. The Configuration Register is set by writing to pointer address 09h and read by reading from pointer address 09h. [Table 6](#) summarizes the bits of Configuration Register 1.

The shutdown (SD) bit (bit 6) enables or disables the temperature measurement circuitry. If SD = '0', the TMP422 convert continuously at the rate set in the conversion rate register. When SD is set to '1', the TMP422 stops converting when the current conversion sequence is complete and enter a shutdown mode. When SD is set to '0' again, the TMP422 resumes continuous conversions. When SD = '1', a single conversion can be started by writing to the One-Shot Register. See the [One-Shot Conversion](#) section for more information.

The temperature range is set by configuring the RANGE bit (bit 2) of the Configuration Register. Setting this bit low configures the TMP422 for the standard measurement range (–40°C to +127°C); temperature conversions will be stored in the standard binary format. Setting bit 2 high configures the TMP422 for the extended measurement range (–55°C to +150°C); temperature conversions will be stored in the extended binary format (see [Table 2](#)).

The remaining bits of the Configuration Register are reserved and must always be set to '0'. The power-on reset value for this register is 00h.

## CONFIGURATION REGISTER 2

Configuration Register 2 (pointer address 0Ah) controls which temperature measurement channels are enabled and whether the external channels have the resistance correction feature enabled or not. [Table 7](#) summarizes the bits of Configuration Register 2.

**Table 5. Status Register Format**

| STATUS REGISTER (Read = 08h, Write = NA) |                  |    |    |    |    |    |    |    |
|------------------------------------------|------------------|----|----|----|----|----|----|----|
| BIT #                                    | D7               | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| BIT NAME                                 | BUSY             | 0  | 0  | 0  | 0  | 0  | 0  | 0  |
| POR VALUE                                | 0 <sup>(1)</sup> | 0  | 0  | 0  | 0  | 0  | 0  | 0  |

(1) The BUSY bit changes to '1' approximately 1ms following power-up. It is high whenever the TMP422 converts a temperature reading.

**Table 6. Configuration Register 1 Bit Descriptions**

| CONFIGURATION REGISTER 1 (Read/Write = 09h, POR = 00h) |                   |                                            |                      |
|--------------------------------------------------------|-------------------|--------------------------------------------|----------------------|
| BIT                                                    | NAME              | FUNCTION                                   | POWER-ON RESET VALUE |
| 7                                                      | Reserved          | —                                          | 0                    |
| 6                                                      | SD                | 0 = Run<br>1 = Shut Down                   | 0                    |
| 5, 4, 3                                                | Reserved          | —                                          | 0                    |
| 2                                                      | Temperature Range | 0 = –55°C to +127°C<br>1 = –55°C to +150°C | 0                    |
| 1, 0                                                   | Reserved          | —                                          | 0                    |

The RC bit (bit 2) enables the resistance correction feature for the external temperature channels. If RC = '1', series resistance correction is enabled; if RC = '0', resistance correction is disabled. Resistance correction should be enabled for most applications. However, disabling the resistance correction may yield slightly improved temperature measurement noise performance, and reduce conversion time by about 50%, which could lower power consumption when conversion rates of two per second or less are selected.

The LEN bit (bit 3) enables the local temperature measurement channel. If LEN = '1', the local channel is enabled; if LEN = '0', the local channel is disabled.

The REN bit (bit 4) enables external temperature measurement for channel 1. If REN = '1', the first external channel is enabled; if REN = '0', the external channel is disabled.

The REN2 bit (bit 5) enables the second external measurement channel. If REN2 = '1', the second external channel is enabled; if REN2 = '0', the second external channel is disabled.

The temperature measurement sequence is: local channel, external channel 1, external channel 2, external channel 3, shutdown, and delay (to set conversion rate, if necessary). The sequence starts over with the local channel. If any of the channels are disabled, they are bypassed in the sequence.

## CONVERSION RATE REGISTER

The Conversion Rate Register (pointer address 0Bh) controls the rate at which temperature conversions are performed. This register adjusts the idle time between conversions but not the conversion timing itself, thereby allowing the TMP422 power dissipation to be balanced with the temperature register update rate. [Table 8](#) describes the conversion rate options and corresponding current consumption. A one-shot command can be used during the idle time between conversions to immediately start temperature conversions on all enabled channels.

**Table 7. Configuration Register 2 Bit Descriptions**

| CONFIGURATION REGISTER 2 (Read/Write = 0Ah, POR = 3Ch) |          |                                                                         |                      |
|--------------------------------------------------------|----------|-------------------------------------------------------------------------|----------------------|
| BIT                                                    | NAME     | FUNCTION                                                                | POWER-ON RESET VALUE |
| 7                                                      | Reserved | —                                                                       | 0                    |
| 6                                                      | REN3     | 0 = External Channel 3 Disabled<br>1 = External Channel 3 Enabled       | 0                    |
| 5                                                      | REN2     | 0 = External Channel 2 Disabled<br>1 = External Channel 2 Enabled       | 1                    |
| 4                                                      | REN      | 0 = External Channel 1 Disabled<br>1 = External Channel 1 Enabled       | 1                    |
| 3                                                      | LEN      | 0 = Local Channel Disabled<br>1 = Local Channel Enabled                 | 1                    |
| 2                                                      | RC       | 0 = Resistance Correction Disabled<br>1 = Resistance Correction Enabled | 1                    |
| 1, 0                                                   | Reserved | —                                                                       | 0                    |

**Table 8. Conversion Rate Register**

| CONVERSION RATE REGISTER (Read/Write = 0Bh, POR = 07h) |    |    |    |    |    |    |    |                  | AVERAGE I <sub>Q</sub> (TYP) (μA) |                       |
|--------------------------------------------------------|----|----|----|----|----|----|----|------------------|-----------------------------------|-----------------------|
| R7                                                     | R6 | R5 | R4 | R3 | R2 | R1 | R0 | CONVERSIONS/SEC  | V <sub>S</sub> = 2.7V             | V <sub>S</sub> = 5.5V |
| 0                                                      | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0.0625           | 11                                | 32                    |
| 0                                                      | 0  | 0  | 0  | 0  | 0  | 0  | 1  | 0.125            | 17                                | 38                    |
| 0                                                      | 0  | 0  | 0  | 0  | 0  | 1  | 0  | 0.25             | 28                                | 49                    |
| 0                                                      | 0  | 0  | 0  | 0  | 0  | 1  | 1  | 0.5              | 47                                | 69                    |
| 0                                                      | 0  | 0  | 0  | 0  | 1  | 0  | 0  | 1                | 80                                | 103                   |
| 0                                                      | 0  | 0  | 0  | 0  | 1  | 0  | 1  | 2                | 128                               | 155                   |
| 0                                                      | 0  | 0  | 0  | 0  | 1  | 1  | 0  | 4 <sup>(1)</sup> | 190                               | 220                   |
| 0                                                      | 0  | 0  | 0  | 0  | 1  | 1  | 1  | 8 <sup>(2)</sup> | 373                               | 413                   |

- (1) Conversion rate shown is for only one or two enabled measurement channels. When three channels are enabled, the conversion rate is 2 and 2/3 conversions-per-second. When four channels are enabled, the conversion rate is 2 per second.
- (2) Conversion rate shown is for only one enabled measurement channel. When two channels are enabled, the conversion rate is 4 conversions-per-second. When three channels are enabled, the conversion rate is 2 and 2/3 conversions-per-second. When four channels are enabled, the conversion rate is 2 conversions-per-second.

## ONE-SHOT CONVERSION

When the TMP422 is in shutdown mode (SD = 1 in the Configuration Register 1), a single conversion is started on all enabled channels by writing any value to the One-Shot Start Register, pointer address 0Fh. This write operation starts one conversion; the TMP422 returns to shutdown mode when that conversion completes. The value of the data sent in the write command is irrelevant and is not stored by the TMP422. When the TMP422 are in shutdown mode, the conversion sequence currently in process must be completed before a one-shot command can be issued. One-shot commands issued during a conversion are ignored.

## n-FACTOR CORRECTION REGISTER

The TMP422 allows for a different  $n$ -factor value to be used for converting remote channel measurements to temperature. The remote channel uses sequential current excitation to extract a differential  $V_{BE}$  voltage measurement to determine the temperature of the remote transistor. Equation 1 describes this voltage and temperature.

$$V_{BE2} - V_{BE1} = \frac{\eta k T}{q} \ln \left( \frac{I_2}{I_1} \right) \quad (1)$$

The value  $n$  in Equation 1 is a characteristic of the particular transistor used for the remote channel. The power-on reset value for the TMP422 is  $n = 1.008$ . The value in the n-Factor Correction Register may be used to adjust the effective n-factor according to Equation 2 and Equation 3.

$$\eta_{eff} = \left( \frac{1.008 \times 300}{300 - N_{ADJUST}} \right) \quad (2)$$

$$N_{ADJUST} = 300 - \left( \frac{300 \times 1.008}{\eta_{eff}} \right) \quad (3)$$

The  $n$ -correction value must be stored in two's-complement format, yielding an effective data range from –128 to +127. The  $n$ -correction value may be written to and read from pointer address 21h. The  $n$ -correction value for the second remote channel may be written and read from pointer address 22h. The register power-on reset value is 00h, thus having no effect unless the register is written to.

## SOFTWARE RESET

The TMP422 may be reset by writing any value to the Software Reset Register (pointer address FCh). This action restores the power-on reset state to all of the TMP422 registers as well as aborts any conversion in process. The TMP422 also supports reset via the two-wire general call address (0000 0000). The [General Call Reset](#) section contains more information.

**Table 9. n-Factor Range**

| BINARY    | N <sub>ADJUST</sub> |         | n        |
|-----------|---------------------|---------|----------|
|           | HEX                 | DECIMAL |          |
| 0111 1111 | 7F                  | 127     | 1.747977 |
| 0000 1010 | 0A                  | 10      | 1.042759 |
| 0000 1000 | 08                  | 8       | 1.035616 |
| 0000 0110 | 06                  | 6       | 1.028571 |
| 0000 0100 | 04                  | 4       | 1.021622 |
| 0000 0010 | 02                  | 2       | 1.014765 |
| 0000 0001 | 01                  | 1       | 1.011371 |
| 0000 0000 | 00                  | 0       | 1.008    |
| 1111 1111 | FF                  | –1      | 1.004651 |
| 1111 1110 | FE                  | –2      | 1.001325 |
| 1111 1100 | FC                  | –4      | 0.994737 |
| 1111 1010 | FA                  | –6      | 0.988235 |
| 1111 1000 | F8                  | –8      | 0.981818 |
| 1111 0110 | F6                  | –10     | 0.975484 |
| 1000 0000 | 80                  | –128    | 0.706542 |

## GENERAL CALL RESET

The TMP422 supports reset via the two-wire General Call address 00h (0000 0000b). The TMP422 acknowledges the General Call address and respond to the second byte. If the second byte is 06h (0000 0110b), the TMP422 executes a software reset. This software reset restores the power-on reset state to all TMP422 registers, and aborts any conversion in progress. The TMP422 takes no action in response to other values in the second byte.

## IDENTIFICATION REGISTERS

The TMP422 allows for the two-wire bus controller to query the device for manufacturer and device IDs to enable software identification of the device at the particular two-wire bus address. The manufacturer ID is obtained by reading from pointer address FEh. The device ID is obtained by reading from pointer address FFh. The TMP422 returns 55h for the manufacturer code. The TMP422 returns 22h for the device ID. These registers are read-only.

## BUS OVERVIEW

The TMP422 is SMBus interface-compatible. In SMBus protocol, the device that initiates the transfer is called a master, and the devices controlled by the master are slaves. The bus must be controlled by a master device that generates the serial clock (SCL), controls the bus access, and generates the START and STOP conditions.

To address a specific device, a START condition is initiated. START is indicated by pulling the data line (SDA) from a high-to-low logic level while SCL is high. All slaves on the bus shift in the slave address byte, with the last bit indicating whether a read or write operation is intended. During the ninth clock pulse, the slave being addressed responds to the master by generating an Acknowledge and pulling SDA low.

Data transfer is then initiated and sent over eight clock pulses followed by an Acknowledge bit. During data transfer SDA must remain stable while SCL is high, because any change in SDA while SCL is high is interpreted as a control signal.

Once all data have been transferred, the master generates a STOP condition. STOP is indicated by pulling SDA from low to high, while SCL is high.

## SERIAL INTERFACE

The TMP422 operates only as a slave device on either the two-wire bus or the SMBus. Connections to either bus are made via the open-drain I/O lines, SDA and SCL. The SDA and SCL pins feature integrated spike suppression filters and Schmitt triggers to minimize the effects of input spikes and bus noise. The TMP422 supports the transmission protocol for fast (1kHz to 400kHz) and high-speed (1kHz to 3.4MHz) modes. All data bytes are transmitted MSB first.

## SERIAL BUS ADDRESS

To communicate with the TMP422, the master must first address slave devices via a slave address byte. The slave address byte consists of seven address bits, and a direction bit indicating the intent of executing a read or write operation.

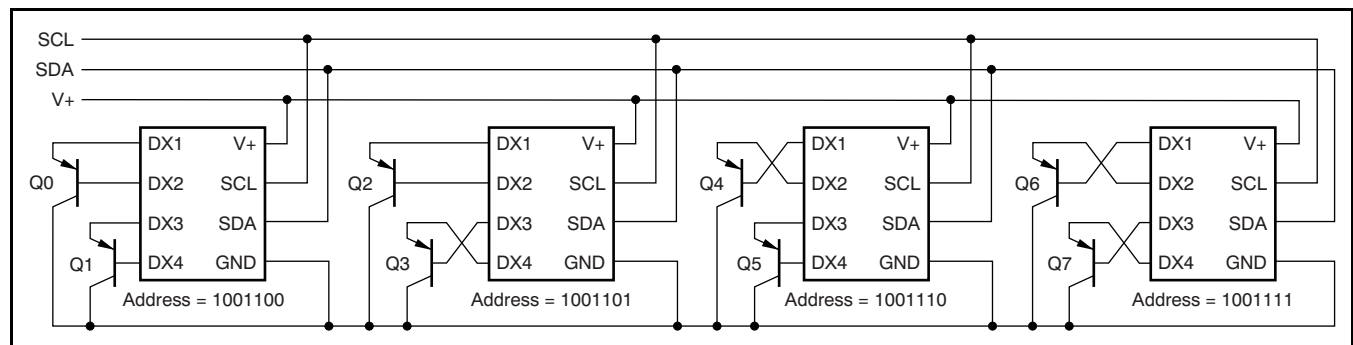
### Two-Wire Interface Slave Device Addresses

The TMP422 supports four slave device addresses.

The slave device address is set by the connections between the external transistors and the TMP422 according to [Figure 13](#) and [Table 10](#). If one of the channels is unused, the respective DXP connection should be connected to GND, and the DXN connection should be left unconnected. The polarity of the transistor for external channel 2 (pins 3 and 4) sets the least significant bit of the slave address. The polarity of the transistor for external channel 1 (pins 1 and 2) sets the next least significant bit of the slave address.

**Table 10. Slave Address Options**

| TWO-WIRE SLAVE ADDRESS | DX1  | DX2  | DX3  | DX4  |
|------------------------|------|------|------|------|
| 1001 100               | DXP1 | DXN1 | DXP2 | DXN2 |
| 1001 101               | DXP1 | DXN1 | DXN2 | DXP2 |
| 1001 110               | DXN1 | DXP1 | DXP2 | DXN2 |
| 1001 111               | DXN1 | DXP1 | DXN2 | DXP2 |



**Figure 13. TMP422 Connections for Device Address Setup**

The TMP422 checks the polarity of the external transistor at power-on, or after software reset, by forcing current to pin 1 while connecting pin 2 to approximately 0.6V. If the voltage on pin 1 does not pull up to near the V+ of the TMP422, pin 1 functions as DXP for channel 1, and the second LSB of the slave address is '0'. If the voltage on pin 1 does pull up to near V+, the TMP422 forces current to pin 2 while connecting pin 1 to 0.6V. If the voltage on pin 2 does not pull up to near V+, the TMP422 uses pin 2 for DXP of channel 1, and sets the second LSB of the slave address to '1'. If both pins are shorted to GND or if both pins are open, the TMP422 uses pin 1 as DXP and sets the address bit to '0'. This process is then repeated for channel 2 (pins 3 and 4).

If the TMP422 is to be used with transistors that are located on another IC (such as a CPU, DSP, or graphics processor), it is recommended to use pin 1 or pin 3 as DXP to ensure correct address detection. If the other IC has a lower supply voltage or is not powered when the TMP422 tries to detect the slave address, a protection diode may turn on during the detection process and the TMP422 may incorrectly choose the DXP pin and corresponding slave address. Using pin 1 and/or pin 3 for transistors that are on other ICs ensures correct operation independent of supply sequencing or levels.

## READ/WRITE OPERATIONS

Accessing a particular register on the TMP422 is accomplished by writing the appropriate value to the Pointer Register. The value for the Pointer Register is the first byte transferred after the slave address byte with the R/W bit low. Every write operation to the TMP422 requires a value for the Pointer Register (see [Figure 15](#)).

When reading from the TMP422, the last value stored in the Pointer Register by a write operation is used to determine which register is read by a read operation. To change which register is read for a read operation, a new value must be written to the Pointer Register. This transaction is accomplished by issuing a slave address byte with the R/W bit low, followed by the Pointer Register byte; no additional data are required. The master can then generate a START condition and send the slave address byte with the R/W bit high to initiate the read command. See [Figure 17](#) for details of this sequence. If repeated reads from the same register are desired, it is not necessary to continually send the Pointer Register bytes, because the TMP422 retain the Pointer Register value until it is changed by the next write operation. Note that register bytes are sent MSB first, followed by the LSB.

Read operations should be terminated by issuing a Not-Acknowledge command at the end of the last byte to be read. For a single-byte operation, the master should leave the SDA line high during the Acknowledge time of the first byte that is read from the slave. For a two-byte read operation, the master must pull SDA low during the Acknowledge time of the first byte read, and should leave SDA high during the Acknowledge time of the second byte read from the slave.

## TIMING DIAGRAMS

The TMP422 is two-wire and SMBus-compatible. [Figure 14](#) to [Figure 17](#) describe the timing for various operations on the TMP422. Parameters for [Figure 14](#) are defined in [Table 11](#). Bus definitions are:

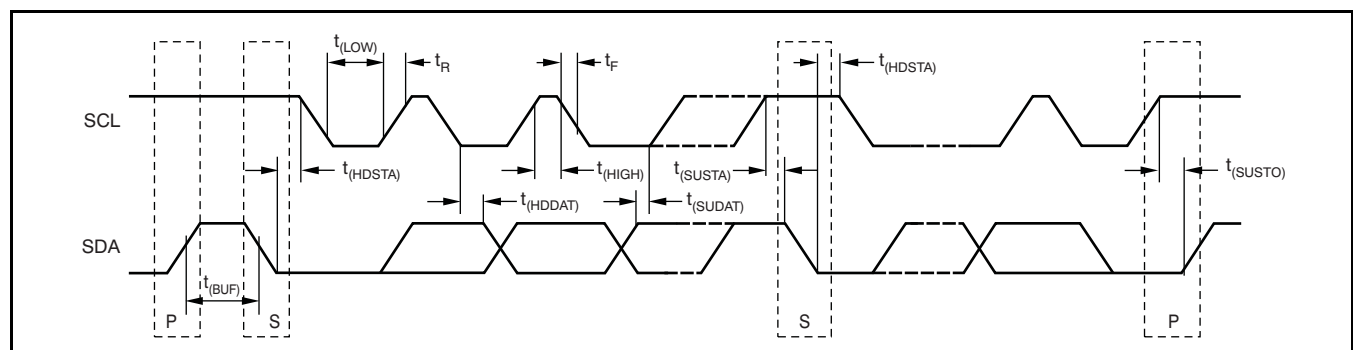
**Bus Idle:** Both SDA and SCL lines remain high.

**Start Data Transfer:** A change in the state of the SDA line, from high to low, while the SCL line is high, defines a START condition. Each data transfer initiates with a START condition. Denoted as S in [Figure 14](#).

**Stop Data Transfer:** A change in the state of the SDA line from low to high while the SCL line is high defines a STOP condition. Each data transfer terminates with a repeated START or STOP condition. Denoted as P in [Figure 14](#).

**Data Transfer:** The number of data bytes transferred between a START and a STOP condition is not limited and is determined by the master device. The receiver acknowledges data transfer.

**Acknowledge:** Each receiving device, when addressed, is obliged to generate an Acknowledge bit. A device that acknowledges must pull down the SDA line during the Acknowledge clock pulse in such a way that the SDA line is stable low during the high period of the Acknowledge clock pulse. Setup and hold times must be taken into account. On a master receive, data transfer termination can be signaled by the master generating a Not-Acknowledge on the last byte that has been transmitted by the slave.

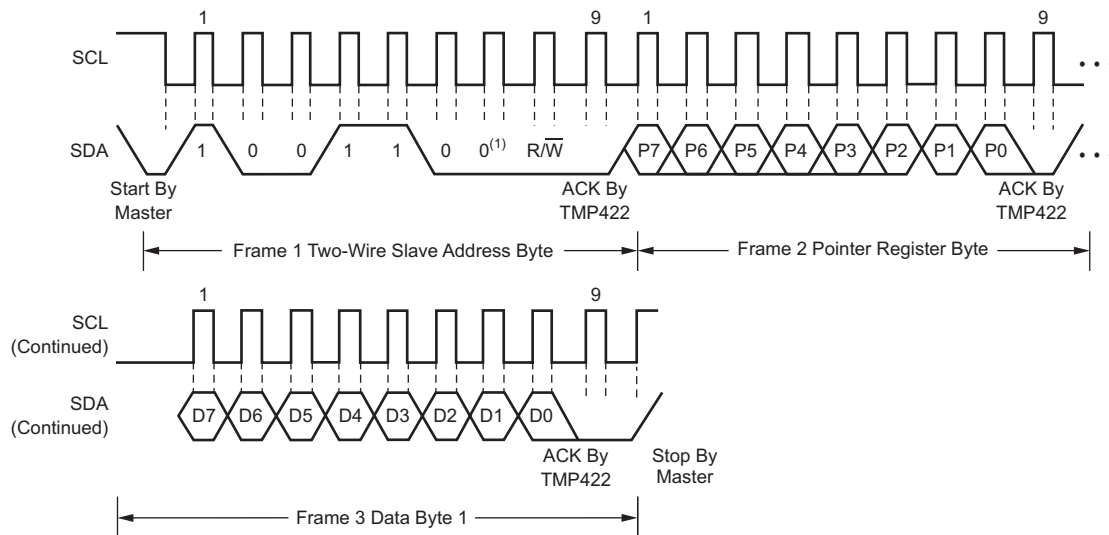


**Figure 14. Two-Wire Timing Diagram**

**Table 11. Timing Characteristics for Figure 14**

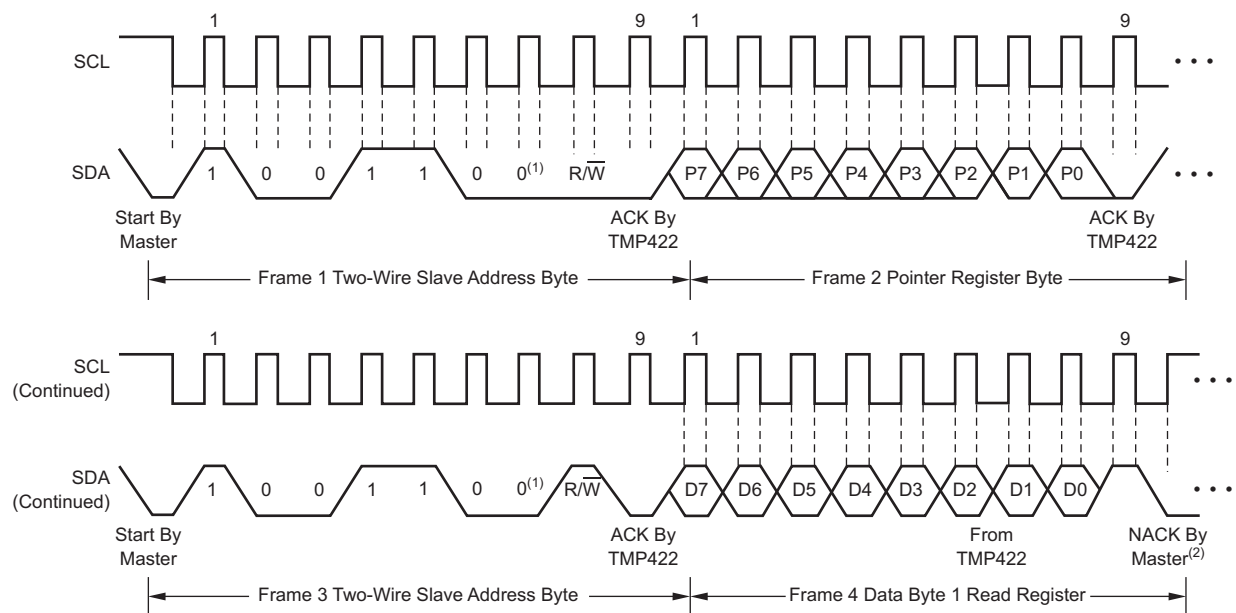
| PARAMETER                                                                                  |               | FAST MODE        |      | HIGH-SPEED MODE  |     | UNIT |
|--------------------------------------------------------------------------------------------|---------------|------------------|------|------------------|-----|------|
|                                                                                            |               | MIN              | MAX  | MIN              | MAX |      |
| SCL Operating Frequency                                                                    | $f_{(SCL)}$   | 0.001            | 0.4  | 0.001            | 3.4 | MHz  |
| Bus Free Time Between STOP and START Condition                                             | $t_{(BUF)}$   | 600              |      | 160              |     | ns   |
| Hold time after repeated START condition. After this period, the first clock is generated. | $t_{(HDSTA)}$ | 100              |      | 100              |     | ns   |
| Repeated START Condition Setup Time                                                        | $t_{(SUSTA)}$ | 100              |      | 100              |     | ns   |
| STOP Condition Setup Time                                                                  | $t_{(SUSTO)}$ | 100              |      | 100              |     | ns   |
| Data Hold Time                                                                             | $t_{(HDDAT)}$ | 0 <sup>(1)</sup> |      | 0 <sup>(2)</sup> |     | ns   |
| Data Setup Time                                                                            | $t_{(SUDAT)}$ | 100              |      | 10               |     | ns   |
| SCL Clock LOW Period                                                                       | $t_{(LOW)}$   | 1300             |      | 160              |     | ns   |
| SCL Clock HIGH Period                                                                      | $t_{(HIGH)}$  | 600              |      | 60               |     | ns   |
| Clock/Data Fall Time                                                                       | $t_F$         |                  | 300  |                  | 160 | ns   |
| Clock/Data Rise Time                                                                       | $t_R$         |                  | 300  |                  | 160 | ns   |
| for SCL $\leq$ 100kHz                                                                      | $t_R$         |                  | 1000 |                  |     | ns   |

- (1) For cases with fall time of SCL less than 20ns and/or the rise or fall time of SDA less than 20ns, the hold time should be greater than 20ns.
- (2) For cases with a fall time of SCL less than 10ns and/or the rise or fall time of SDA less than 10ns, the hold time should be greater than 10ns.



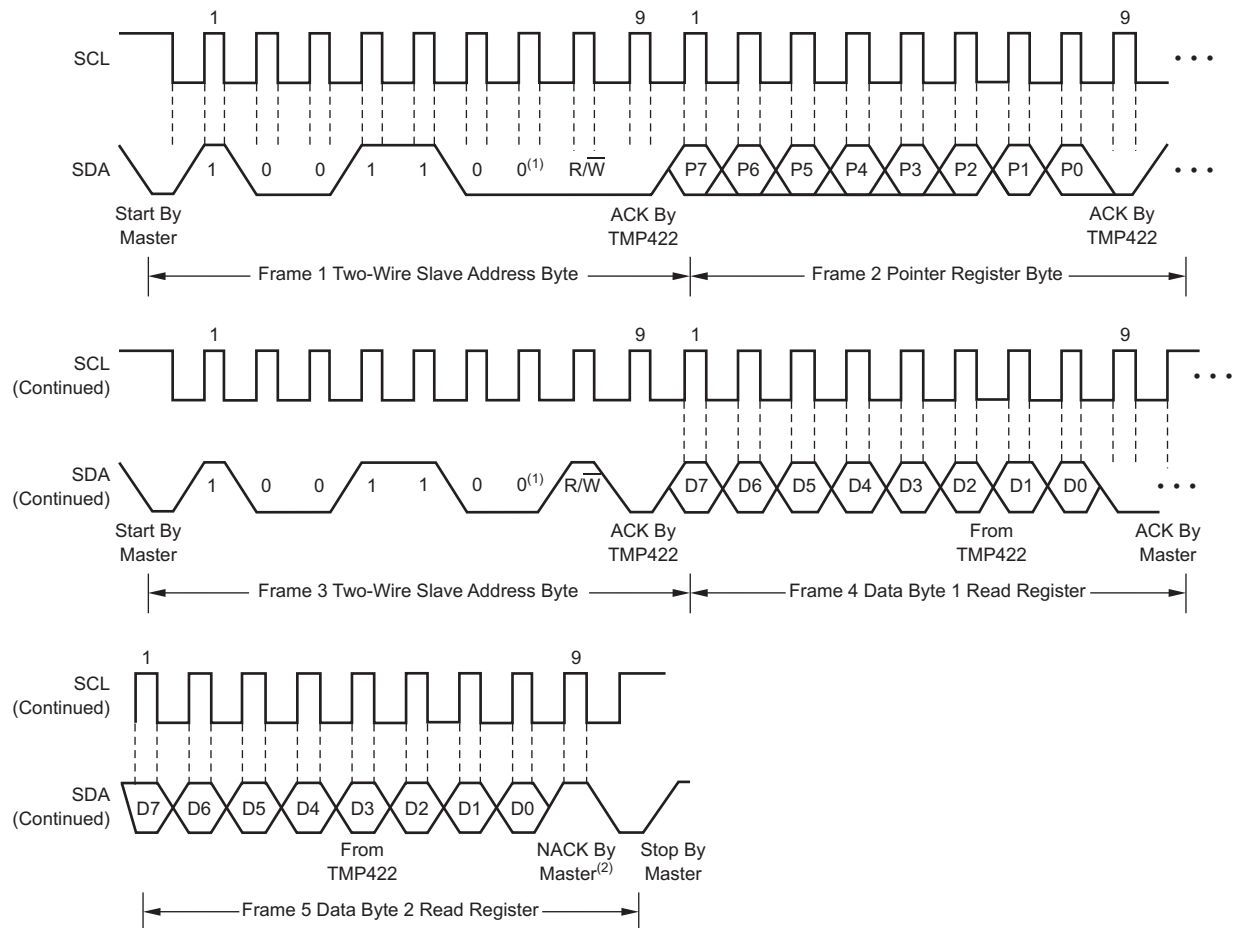
- (1) Slave address 1001100 shown.

**Figure 15. Two-Wire Timing Diagram for Write Word Format**



- (1) Slave address 1001100 shown.  
 (2) Master should leave SDA high to terminate a single-byte read operation.

**Figure 16. Two-Wire Timing Diagram for Single-Byte Read Format**



(1) Slave address 1001100 shown.

(2) Master should leave SDA high to terminate a two-byte read operation.

**Figure 17. Two-Wire Timing Diagram for Two-Byte Read Format**

## HIGH-SPEED MODE

In order for the two-wire bus to operate at frequencies above 400kHz, the master device must issue a High-Speed mode (Hs-mode) master code (0000 1xxx) as the first byte after a START condition to switch the bus to high-speed operation. The TMP422 does not acknowledge this byte, but switches the input filters on SDA and SCL and the output filter on SDA to operate in Hs-mode, allowing transfers at up to 3.4MHz. After the Hs-mode master code has been issued, the master transmits a two-wire slave address to initiate a data transfer operation. The bus continues to operate in Hs-mode until a STOP condition occurs on the bus. Upon receiving the STOP condition, the TMP422 switch the input and output filters back to fast mode operation.

## TIMEOUT FUNCTION

The TMP422 reset the serial interface if either SCL or SDA are held low for 30ms (typical) between a START and STOP condition. If the TMP422 is holding the bus low, the device releases the bus and waits for a START condition. To avoid activating the timeout function, it is necessary to maintain a communication speed of at least 1kHz for the SCL operating frequency.

## SHUTDOWN MODE (SD)

The TMP422 Shutdown Mode allows the user to save maximum power by shutting down all device circuitry other than the serial interface, reducing current consumption to typically less than 3 $\mu$ A; see [Figure 10, Shutdown Quiescent Current vs Supply Voltage](#). Shutdown Mode is enabled when the SD bit (bit 6) of Configuration Register 1 is high; the device shuts down once the current conversion is completed. When SD is low, the device maintains a continuous conversion state.

## SENSOR FAULT

The TMP422 can sense an open circuit. Short-circuit conditions return a value of  $-64^{\circ}\text{C}$ . The detection circuitry consists of a voltage comparator that trips when the voltage at DXP exceeds  $(V+) - 0.6\text{V}$  (typical). The comparator output is continuously checked during a conversion. If a fault is detected, the OPEN bit (bit 0) in the temperature result register is set to '1' and the rest of the register bits should be ignored.

When not using a remote sensor with the TMP422, the DX pins should be connected (refer to [Table 10](#)) such that DXP connections are grounded and DXN connections are left open (unconnected).

## UNDERVOLTAGE LOCKOUT

The TMP422 senses when the power-supply voltage has reached a minimum voltage level for the ADC to function. The detection circuitry consists of a voltage comparator that enables the ADC after the power supply ( $V+$ ) exceeds 2.45V (typical). The comparator output is continuously checked during a conversion. The TMP422 does not perform a temperature conversion if the power supply is not valid. The PVLD bit (bit 1, see [Table 4](#)) of the individual Local/Remote Temperature Register is set to '1' and the temperature result may be incorrect.

## FILTERING

Remote junction temperature sensors are usually implemented in a noisy environment. Noise is most often created by fast digital signals, and it can corrupt measurements. The TMP422 has a built-in 65kHz filter on the inputs of DX1 through DX4 to minimize the effects of noise. However, a bypass capacitor placed differentially across the inputs of the remote temperature sensor is recommended to make the application more robust against unwanted coupled signals. The value of this capacitor should be between 100pF and 1nF. Some applications attain better overall accuracy with additional series resistance; however, this increased accuracy is *application-specific*. When series resistance is added, the total value should not be greater than 3k $\Omega$ . If filtering is needed, suggested component values are 100pF and 50 $\Omega$  on each input; exact values are application-specific.

## REMOTE SENSING

The TMP422 is designed to be used with either discrete transistors or substrate transistors built into processor chips and ASICs. Either NPN or PNP transistors can be used, as long as the base-emitter junction is used as the remote temperature sense. NPN transistors must be diode-connected. PNP transistors can either be transistor- or diode-connected (see [Figure 11](#)).

Errors in remote temperature sensor readings are typically the consequence of the ideality factor and current excitation used by the TMP422 versus the manufacturer-specified operating current for a given transistor. Some manufacturers specify a high-level and low-level current for the temperature-sensing substrate transistors. The TMP422 uses 6 $\mu$ A for  $I_{\text{LOW}}$  and 120 $\mu$ A for  $I_{\text{HIGH}}$ .

The ideality factor ( $n$ ) is a measured characteristic of a remote temperature sensor diode as compared to an ideal diode. The TMP422 allow for different  $n$ -factor values; see the [N-Factor Correction Register](#) section.

The ideality factor for the TMP422 is trimmed to be 1.008. For transistors that have an ideality factor that does not match the TMP422, [Equation 4](#) can be used to calculate the temperature error. Note that for the equation to be used correctly, actual temperature ( $^{\circ}\text{C}$ ) must be converted to kelvins (K).

$$T_{ERR} = \left( \frac{\eta - 1.008}{1.008} \right) \times (273.15 + T(^{\circ}\text{C})) \quad (4)$$

Where:

$n$  = ideality factor of remote temperature sensor

$T(^{\circ}\text{C})$  = actual temperature

$T_{ERR}$  = error in TMP422 because  $n \neq 1.008$

Degree delta is the same for  $^{\circ}\text{C}$  and K

For  $n = 1.004$  and  $T(^{\circ}\text{C}) = 100^{\circ}\text{C}$ :

$$T_{ERR} = \left( \frac{1.004 - 1.008}{1.008} \right) \times (273.15 + 100^{\circ}\text{C})$$

$$T_{ERR} = 1.48^{\circ}\text{C} \quad (5)$$

If a discrete transistor is used as the remote temperature sensor with the TMP422, the best accuracy can be achieved by selecting the transistor according to the following criteria:

1. Base-emitter voltage  $> 0.25\text{V}$  at  $6\mu\text{A}$ , at the highest sensed temperature.
2. Base-emitter voltage  $< 0.95\text{V}$  at  $120\mu\text{A}$ , at the lowest sensed temperature.
3. Base resistance  $< 100\Omega$ .
4. Tight control of  $V_{BE}$  characteristics indicated by small variations in  $h_{FE}$  (that is, 50 to 150).

Based on these criteria, two recommended small-signal transistors are the 2N3904 (NPN) or 2N3906 (PNP).

## MEASUREMENT ACCURACY AND THERMAL CONSIDERATIONS

The temperature measurement accuracy of the TMP422 depends on the remote and/or local temperature sensor being at the same temperature as the system point being monitored. Clearly, if the temperature sensor is not in good thermal contact with the part of the system being monitored, then there will be a delay in the response of the sensor to a temperature change in the system. For remote temperature-sensing applications using a substrate transistor (or a small, SOT23 transistor) placed close to the device being monitored, this delay is usually not a concern.

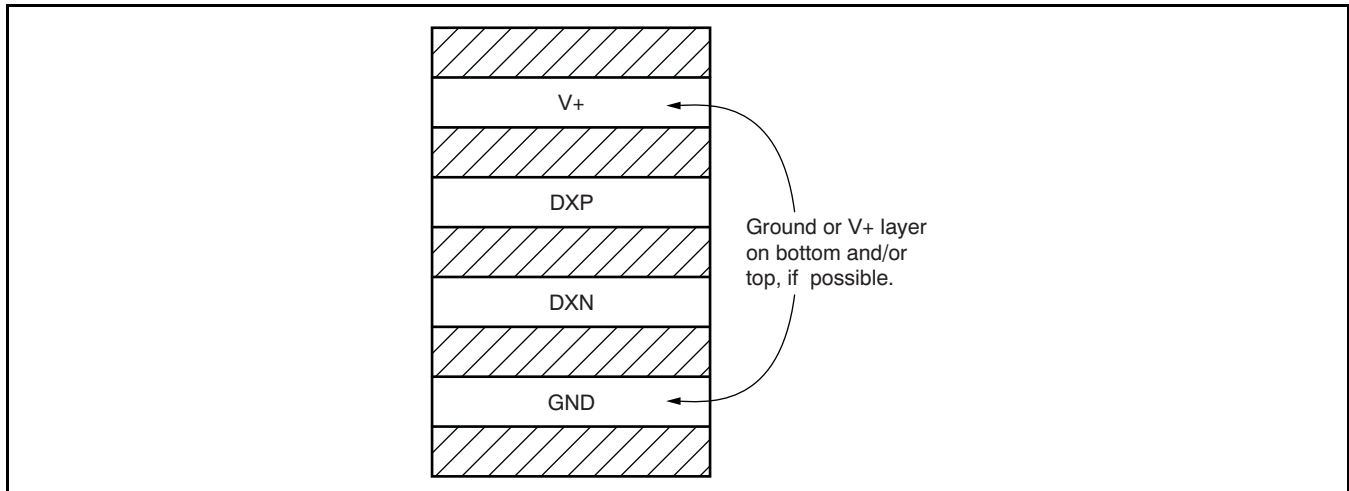
The local temperature sensor inside the TMP422 monitors the ambient air around the device. The thermal time constant for the TMP422 is approximately two seconds. This constant implies that if the ambient air changes quickly by  $100^{\circ}\text{C}$ , it would take the TMP422 about 10 seconds (that is, five thermal time constants) to settle to within  $1^{\circ}\text{C}$  of the final value. In most applications, the TMP422 package is in electrical, and therefore thermal, contact with the printed circuit board (PCB), as well as subjected to forced airflow. The accuracy of the measured temperature directly depends on how accurately the PCB and forced airflow temperatures represent the temperature that the TMP422 is measuring. Additionally, the internal power dissipation of the TMP422 can cause the temperature to rise above the ambient or PCB temperature. The internal power dissipated as a result of exciting the remote temperature sensor is negligible because of the small currents used. For a  $5.5\text{V}$  supply and maximum conversion rate of eight conversions per second, the TMP422 dissipate  $2.3\text{mW}$  ( $\text{PD}_{IQ} = 5.5\text{V} \times 415\mu\text{A}$ ). A  $\theta_{JA}$  of  $168^{\circ}\text{C/W}$  causes the junction temperature to rise approximately  $+0.39^{\circ}\text{C}$  above the ambient.

## LAYOUT CONSIDERATIONS

Remote temperature sensing on the TMP422 measures very small voltages using very low currents; therefore, noise at the IC inputs must be minimized. Most applications using the TMP422 will have high digital content, with several clocks and logic level transitions creating a noisy environment. Layout should adhere to the following guidelines:

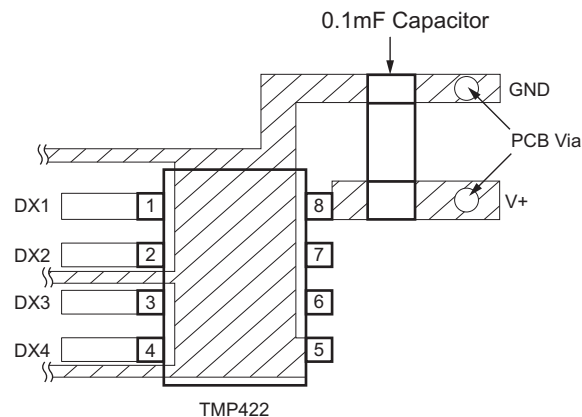
1. Place the TMP422 as close to the remote junction sensor as possible.
2. Route the DXP and DXN traces next to each other and shield them from adjacent signals through the use of ground guard traces; see [Figure 18](#). If a multilayer PCB is used, bury these traces between ground or  $V_{DD}$  planes to shield them from extrinsic noise sources. 5 mil (0.127mm) PCB traces are recommended.
3. Minimize additional thermocouple junctions caused by copper-to-solder connections. If these junctions are used, make the same number and approximate locations of copper-to-solder connections in both the DXP and DXN connections to cancel any thermocouple effects.

4. Use a 0.1μF local bypass capacitor directly between the V+ and GND of the TMP422; see [Figure 19](#). Minimize filter capacitance between DXP and DXN to 1000pF or less for optimum measurement performance. This capacitance includes any cable capacitance between the remote temperature sensor and the TMP422.
5. If the connection between the remote temperature sensor and the TMP422 is less than 8 in (20.32 cm) long, use a twisted-wire pair connection. Beyond 8 in, use a twisted, shielded pair with the shield grounded as close to the TMP422 as possible. Leave the remote sensor connection end of the shield wire open to avoid ground loops and 60Hz pickup.
6. Thoroughly clean and remove all flux residue in and around the pins of the TMP422 to avoid temperature offset readings as a result of leakage paths between DXP or DXN and GND, or between DXP or DXN and V+.



NOTE: Use minimum 5 mil (0.127mm) traces with 5 mil spacing.

**Figure 18. Suggested PCB Layer Cross-Section**



**Figure 19. Suggested Bypass Capacitor Placement and Trace Shielding**

## PACKAGING INFORMATION

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2)            | Lead/Ball Finish<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|--------------------|------|----------------|----------------------------|-------------------------|----------------------|--------------|-------------------------|-------------------------|
| TMP422AMDCNTEP   | ACTIVE        | SOT-23       | DCN                | 8    | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-2-260C-1 YEAR  | -55 to 125   | TMP4                    | <a href="#">Samples</a> |
| V62/11618-01XE   | ACTIVE        | SOT-23       | DCN                | 8    | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-2-260C-1 YEAR  | -55 to 125   | TMP4                    | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "-" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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**OTHER QUALIFIED VERSIONS OF TMP422-EP :**

- Catalog: [TMP422](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product

**TAPE AND REEL INFORMATION**


\*All dimensions are nominal

| Device         | Package Type | Package Drawing | Pins | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|----------------|--------------|-----------------|------|-----|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| TMP422AMDCNTEP | SOT-23       | DCN             | 8    | 250 | 179.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |

## TAPE AND REEL BOX DIMENSIONS

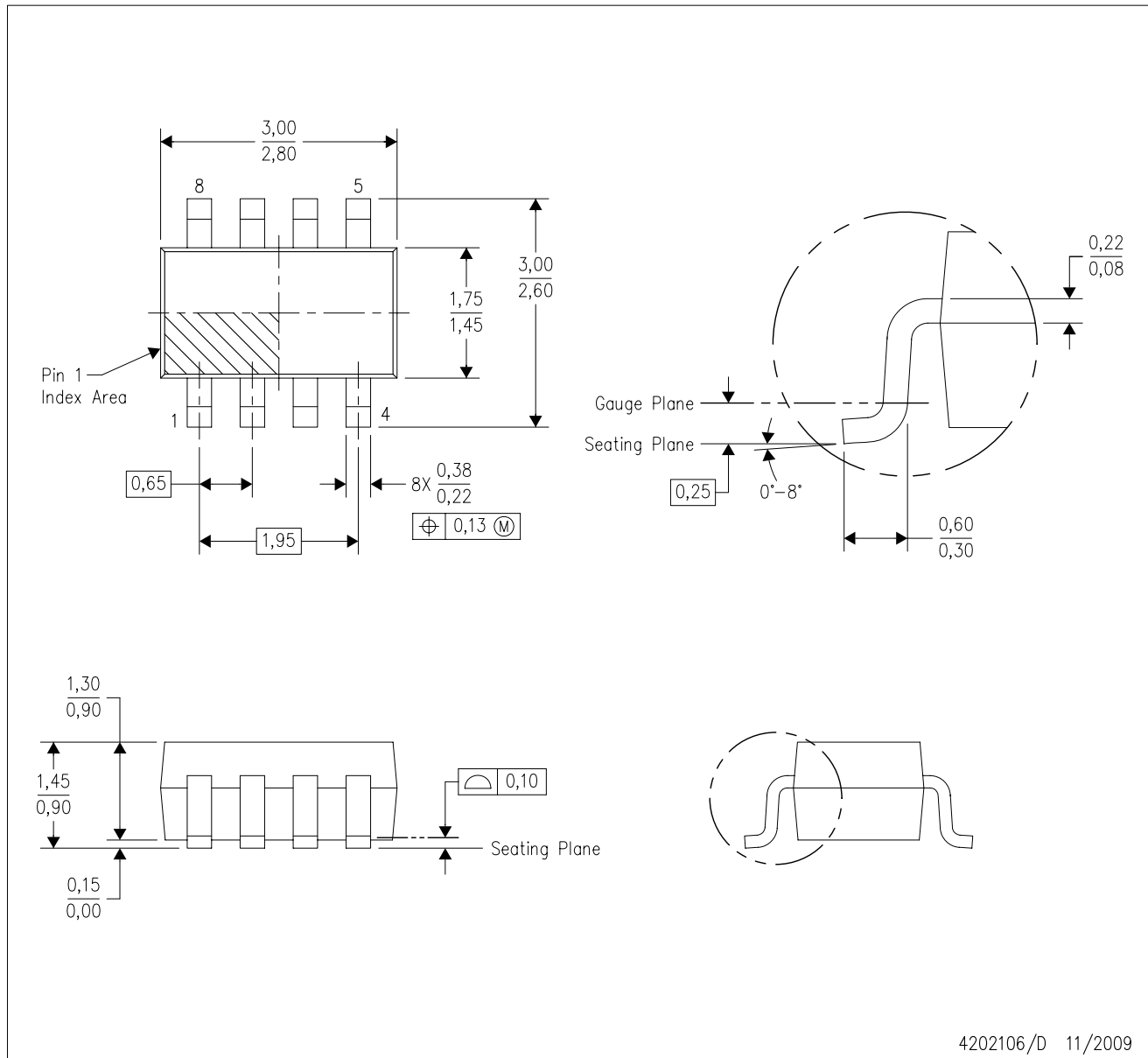


\*All dimensions are nominal

| Device         | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|----------------|--------------|-----------------|------|-----|-------------|------------|-------------|
| TMP422AMDCNTEP | SOT-23       | DCN             | 8    | 250 | 195.0       | 200.0      | 45.0        |

DCN (R-PDSO-G8)

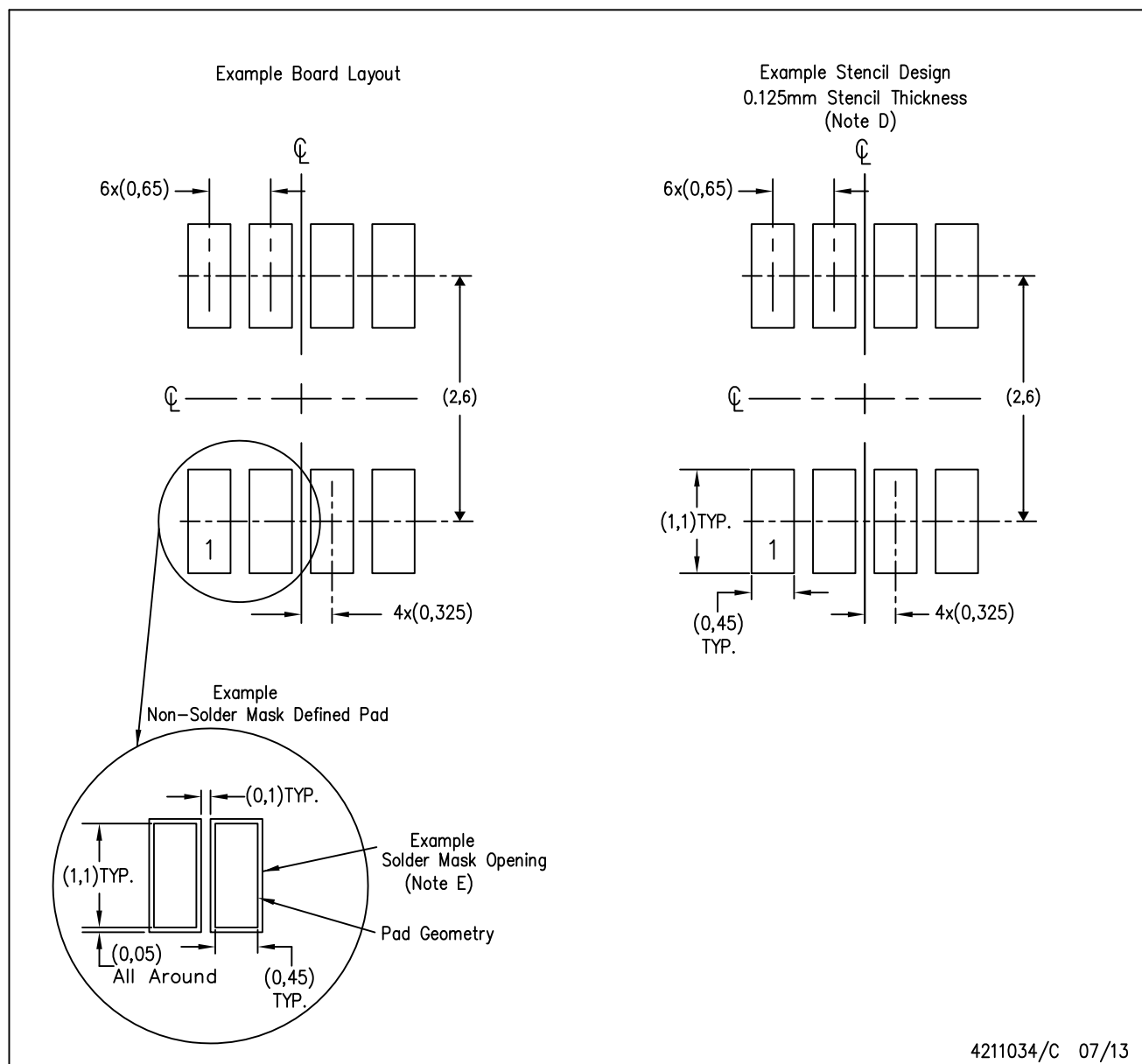
PLASTIC SMALL-OUTLINE PACKAGE (DIE DOWN)



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Package outline exclusive of metal burr & dambar protrusion/intrusion.
  - D. Package outline inclusive of solder plating.
  - E. A visual index feature must be located within the Pin 1 index area.
  - F. Falls within JEDEC MO-178 Variation BA.
  - G. Body dimensions do not include flash or protrusion. Mold flash and protrusion shall not exceed 0.25 per side.

DCN (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE (DIE DOWN)



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Publication IPC-7351 is recommended for alternate designs.
  - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525.
  - E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

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### Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: [info@moschip.ru](mailto:info@moschip.ru)

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